





MagicRay 3D SPI-VSP3000 Series 3D Solder Paste Inspection System with 12MP Industrial Camera 15µm Resolution and 60*45mm FOV

Basic Information

Brand Name: MagicRayModel Number: VSP3000Minimum Order Quantity: 1 PCS

Price: USD+negotiable+pcsPackaging Details: 1000*1500*1700mm

Delivery Time: 1-7 daysPayment Terms: T/T

Supply Ability: 1+pcs+per days



Product Specification

• Equipment Model: VSP3000

Image System Camera: 12MP Industrialcamera
Resolution: 15µm,12µm,10µm
FOV: 60*45mm(12MP,15µm)

Height Resolution: 0.37μm

• Lighting: 3color Ring ShapeLED(RGB)

Height Measurement Projectors

Method:

Movement Structure: X/Y Movement

Platform: Granite
Width Adjustment: Automatic

• Transport Type: Belt

• Board Loading Direction: Lefttoright Or Right To Left(Select At Point Of

Order)

Fixed Rail: Front Rail

Halabala.



More Images









Product Description

MagicRay 3D SPI-VSP3000 Series Solder Paste Inspection System

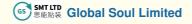
Product Overview

The MagicRay 3D SPI-VSP3000 series provides advanced 3D solder paste inspection capabilities for post-SMT screen printing processes, ensuring superior quality control in PCB assembly.

Key Features

- · Intelligent zero reference point technology ensures precise height measurement accuracy
- Effective detection of solder defects including bridging, breakage, and icicles
- Reliable performance across PCBs with varying color variations
- Automatic solder pad compensation enhances measurement accuracy for both height and volume
- SPC data analysis capabilities for continuous process quality improvement
- Three Point Checks software quickly identifies root causes of solder paste issues including excess, insufficient application, and smearing







+8613728696610



liyi@gs-smt.com



smtmachine-spareparts.com

Room F3B-016, B Block, Hao Yun Lai Bussiness Building, Liutang road , Bao'an District , Shenzhen, China